



Integrated Device Technology, Inc.  
2975 Stender Way, Santa Clara, CA - 95054

## PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **G-0206-08**      DATE: 6/17/2002  
 Product Affected: All square PQFP and TQFP packages shipped in Tape and Reel  
 Date Effective: 9/17/2002

**MEANS OF DISTINGUISHING CHANGED DEVICES:**

- Product Mark
- Back Mark
- Date Code      Starting ww38
- Other

Contact: Geoffrey Cortes  
 Title: Manager, Corporate Quality & Reliability      Attachment::  Yes       No  
 Phone #: (408) 492-8321      See attachment for orientation details.  
 Fax #: (408) 727-2328      Samples: N/A  
 E-mail: [Geoffrey.Cortes@idt.com](mailto:Geoffrey.Cortes@idt.com)

**DESCRIPTION AND PURPOSE OF CHANGE:**

- Die Technology
- Wafer Fabrication Process
- Assembly Process      Pin 1 orientation of all square PQFP and TQFP packages shipped in Tape and Reel packaging will be changed to comply with current EIA Standards (EIA-481-2-A) requirement.
- Equipment
- Material
- Testing
- Manufacturing Site      Additional label will be placed on the intermediate box (pizza box) to alert customer of this change. Please see attachment for details.
- Data Sheet
- Other - Packaging

**RELIABILITY/QUALIFICATION SUMMARY:**

There is no change to the product reliability

**CUSTOMER ACKNOWLEDGMENT OF RECEIPT:**

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.  
 IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: \_\_\_\_\_       **Approval for shipments prior to effective date.**  
 Name/Date: \_\_\_\_\_      E-Mail Address: \_\_\_\_\_  
 Title: \_\_\_\_\_      Phone# /Fax# : \_\_\_\_\_

**CUSTOMER COMMENTS:** \_\_\_\_\_

**IDT ACKNOWLEDGMENT OF RECEIPT:**

RECD. BY: \_\_\_\_\_      DATE: \_\_\_\_\_



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### ATTACHMENT - PCN #: G-0206-08

**PCN Type:** To comply to current EIA Standards (EIA-481-2-A) requirement.

**Data Sheet Change:** No

**Detail of Change:** This change will be implemented on all square PQFP and TQFP packages.

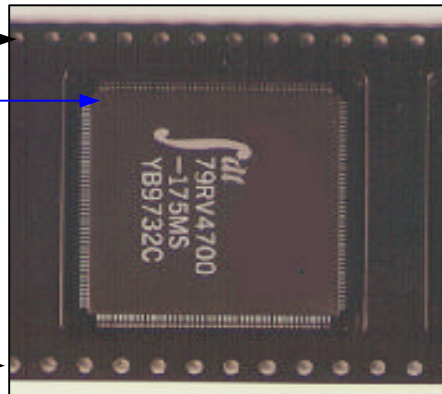
#### FROM:

Round Sprocket Holes

Electrical Pin# 1 and Dimple

User Direction of Unreeling

Elongated Sprocket Holes



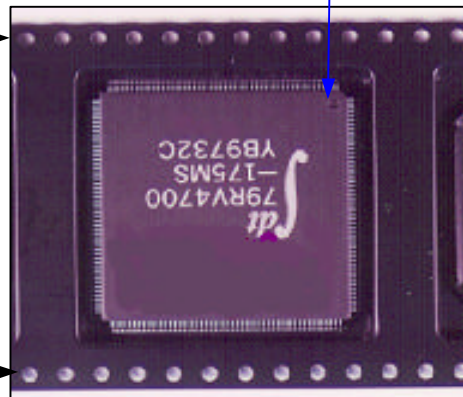
#### TO:

Electrical Pin# 1 and Dimple

Round Sprocket Holes

User Direction of Unreeling

Elongated Sprocket Holes



#### **Conversion schedule:**

Additional label will be placed on the intermediate box (pizza box) to alert customer of this change.  
Label will be placed starting (ww38) 9/17/2002 until 9/17/2003.

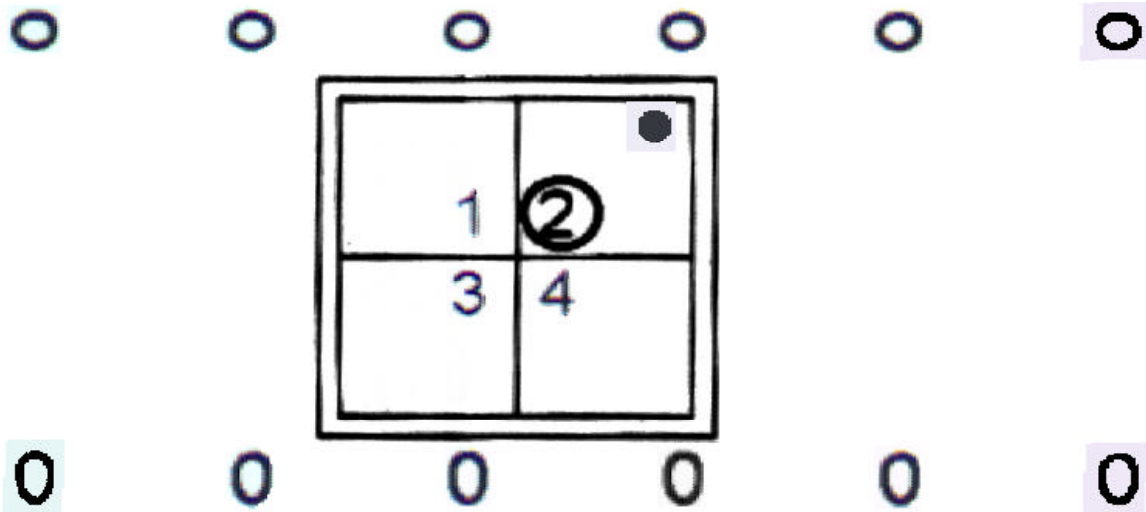


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● Pin One in Quadrant 2